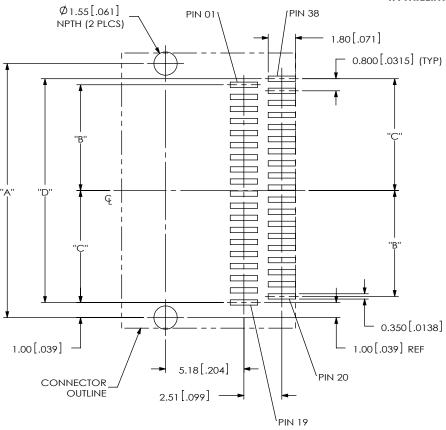
DESIGNED & DIMENSIONED IN MILLIMETERS[INCHES]



QSFP8-038-01-X-D-RA1 SHOWN

TABLE 1						
No. OF POS	"A"	"B"	"C"	"D"	"E"	
*-020	9.600 [0.3780]	3.40 [0.134]	3.80 [0.150]	7.60 [0.299]	9.20 [0.362]	
-038	16.800 [0.6614]	7.00 [0.276]	7.40 [0.291]	14.80 [0.583]	16.40 [0.646]	
*-100	41.600 [1.6378]	19.40 [0.764]	19.80 [0.780]	39.60 [1.559]	41.20 [1.622]	

(* = NOT TOOLED)

NOTES:

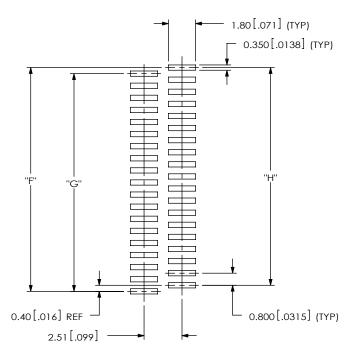
- 1. CONNECTOR ENVELOPE DIMENSIONS. OTHER COMPONENTS PLACED ON PCB SHALL AVOID THIS ZONE.
- 2. QSFP SPECIFICATION (SFF-8436) TO SUPERCEDE SAMTEC RECOMMENDED FOOTPRINT.

PROPRIETARY NOTE

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520 PARK EAST BLVD, NEW ALBANY, IN 47150 PHONE: 812-944-6733 FAX: 812-948-5047 e-Mail info@SAMTEC.com code 55322 NOTE: STENCIL TO BE 0.152[.0060] THICK.



QSFP8-038-01-X-D-RA1 SHOWN

TABLE 2						
No. OF POS	"F"	"G"	"H"			
*-020	7.60 [0.299]	7.20 [0.283]	7.20 [0.283]			
-038	14.80 [0.583]	14.40 [0.567]	14.40 [0.567]			
*-100	39.60 [1.559]	39.20 [1.543]	39.20 [1.543]			

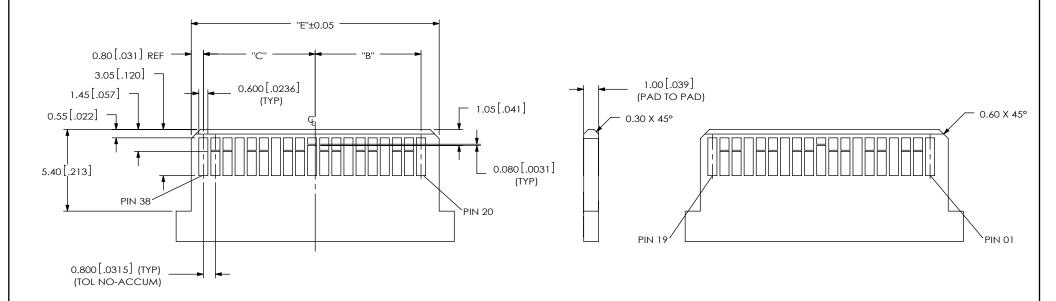
(* = NOT TOOLED)

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DESIGNED & DIMENSIONED IN MILLIMETERS[INCHES]



RECOMMENDED MATING CARD

ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.

NOTES:

1. CONTACT PAD PLATING TO BE 0.38 MICROMETERS [15U"] MIN GOLD OVER 1.27 MICROMETERS [50U"] MIN NICKEL.

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